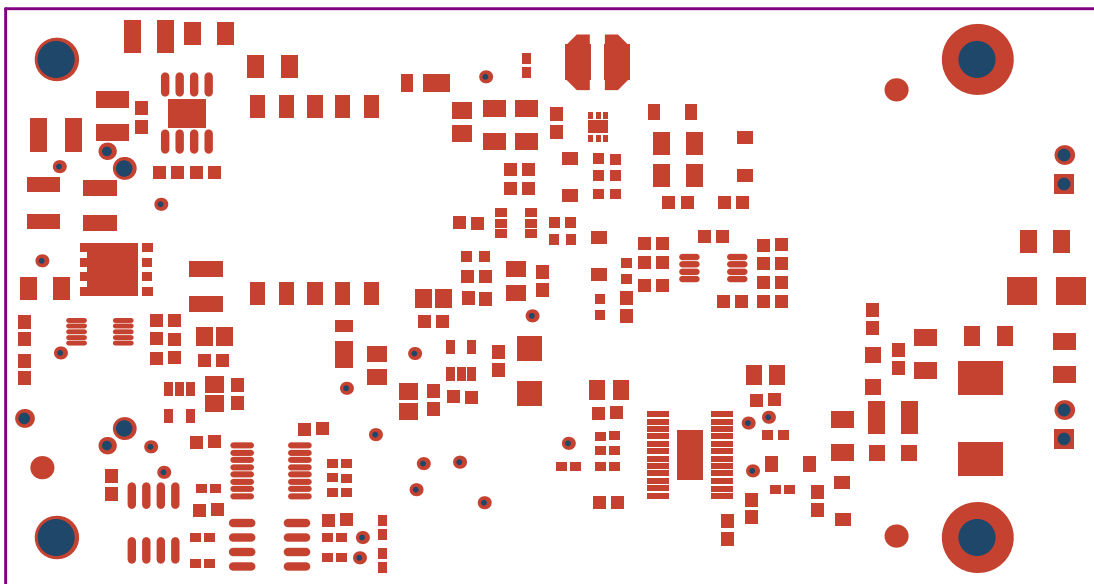
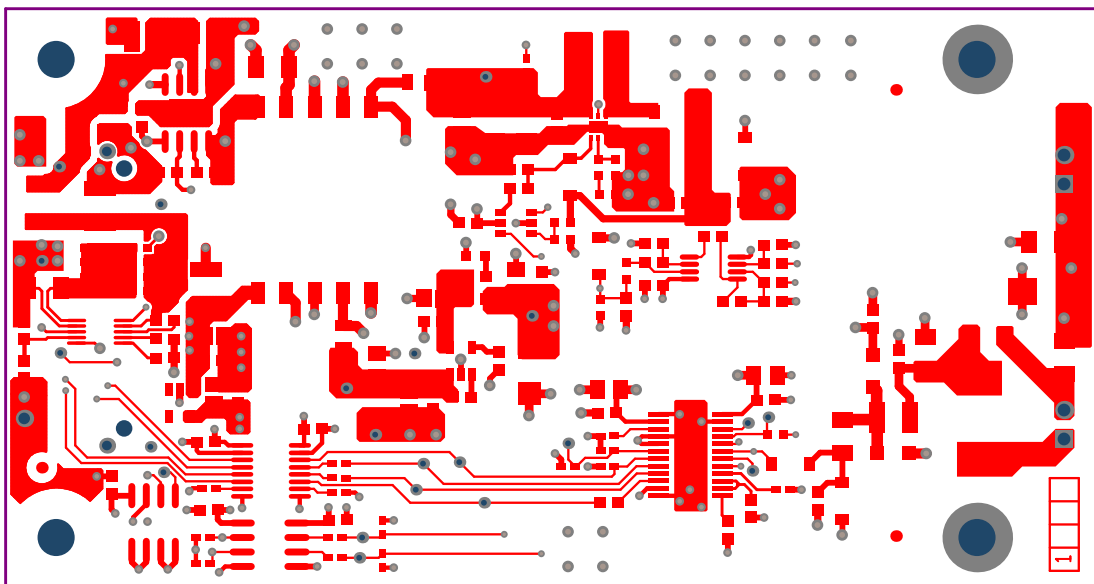


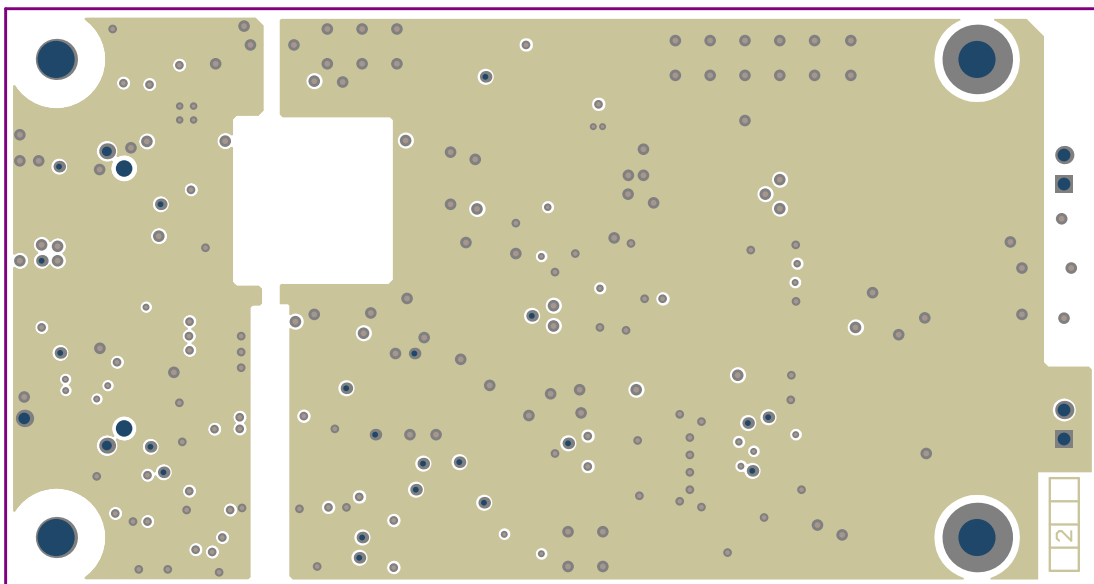
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00231	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 12/1/2014 11:17:12 AM	TEXAS INSTRUMENTS	



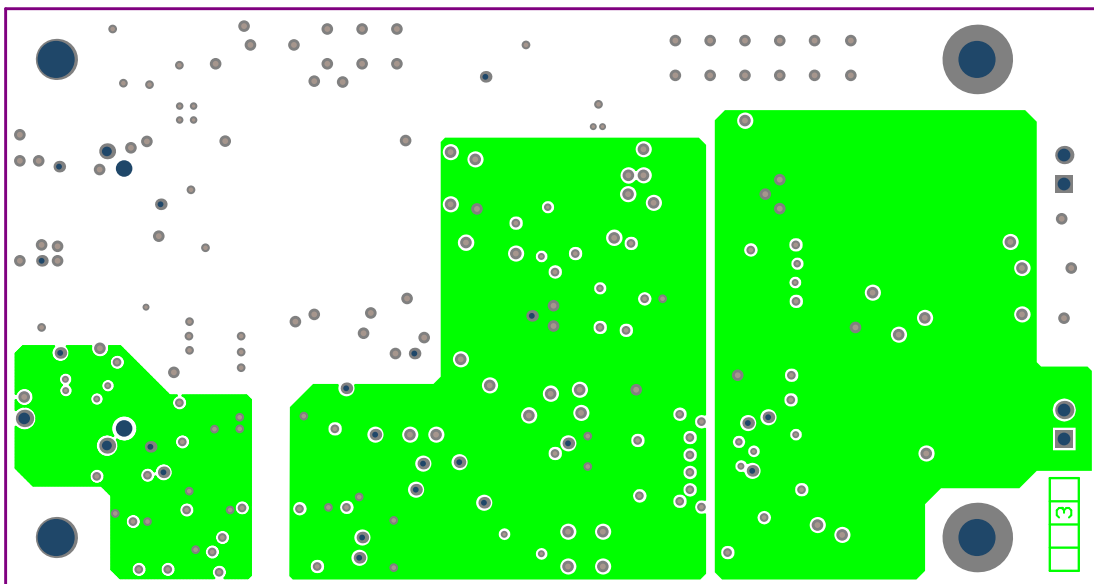
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:TIDA-00231	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 12/1/2014 11:17:13 AM	TEXAS INSTRUMENTS	



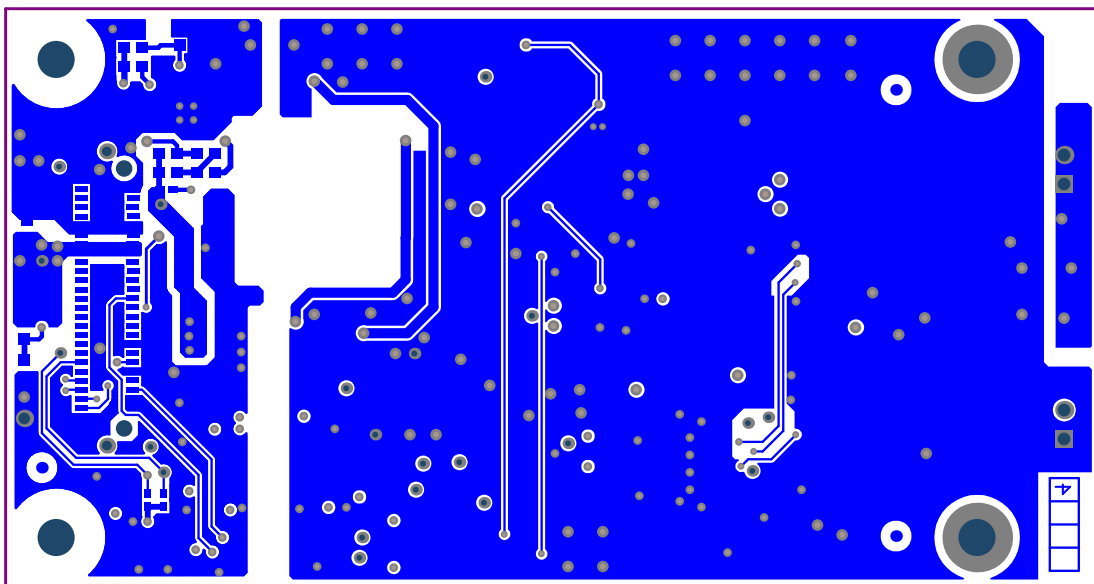
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:TIDA-00231	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 12/1/2014 11:17:13 AM	TEXAS INSTRUMENTS	



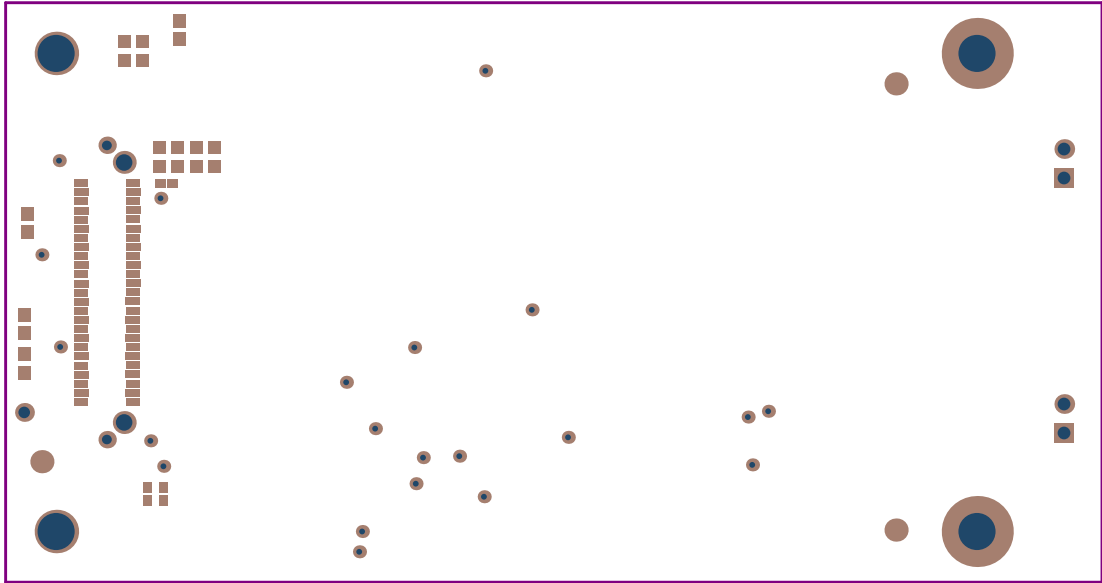
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00231	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = L2_GND-PLANE			
PLOT NAME = MidLayer1	GENERATED : 12/1/2014 11:17:13 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00231	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = L3_PWR-PLANE			
PLOT NAME = MidLayer2	GENERATED : 12/1/2014 11:17:14 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:TIDA-00231	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 12/1/2014 11:17:14 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE

BOARD #: TIDA-00231

REV: E1

SUN REV: Not In VersionControl

LAYER NAME = Bottom Solder

PLOT NAME = Bottom Solder Mask

GENERATED : 12/1/2014 11:17:14 AM

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